Low-power D-type flip-flop with set and reset; positive-edge trigger

Rev. 9 — 6 January 2014

**Product data sheet** 

### 1. General description

The 74AUP1G74 provides a low-power, low-voltage single positive-edge triggered D-type flip-flop with individual data (D), clock (CP), set  $(\overline{SD})$  and reset ( $\overline{RD}$ ) inputs and complementary Q and  $\overline{Q}$  outputs. The  $\overline{SD}$  and  $\overline{RD}$  are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D input must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - ◆ JESD8-5 (1.8 V to 2.7 V)
  - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption;  $I_{CC} = 0.9 \ \mu A$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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### 3. Ordering information

	-			
Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G74DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74AUP1G74GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1
74AUP1G74GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1 $\times$ 0.5 mm	SOT1089
74AUP1G74GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2
74AUP1G74GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 $\times$ 1.6 $\times$ 0.5 mm	SOT902-2
74AUP1G74GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm	SOT1116
74AUP1G74GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1.0 \times 0.35$ mm	SOT1203

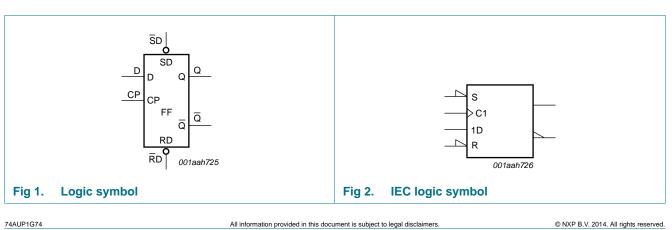
### 4. Marking

### Table 2. Marking codes

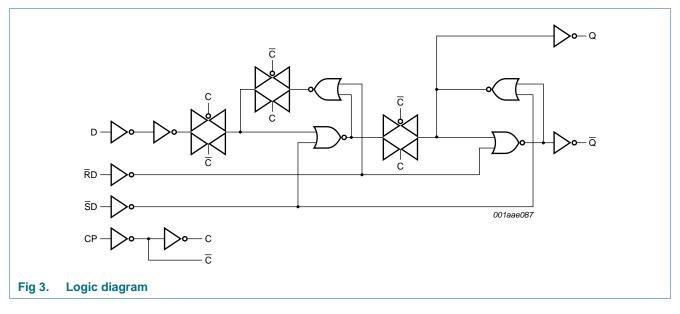
······································	
Type number	Marking code <sup>[1]</sup>
74AUP1G74DC	p74
74AUP1G74GT	p74
74AUP1G74GF	54
74AUP1G74GD	p74
74AUP1G74GM	p74
74AUP1G74GN	54
74AUP1G74GS	54

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 5. Functional diagram

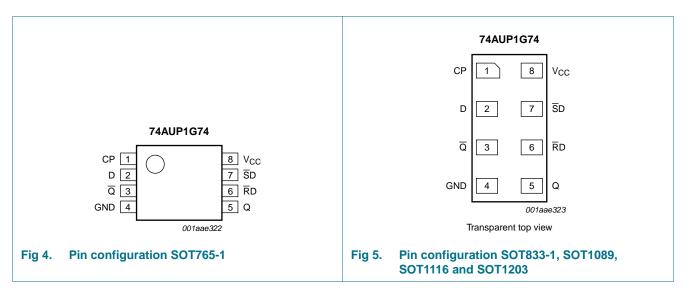


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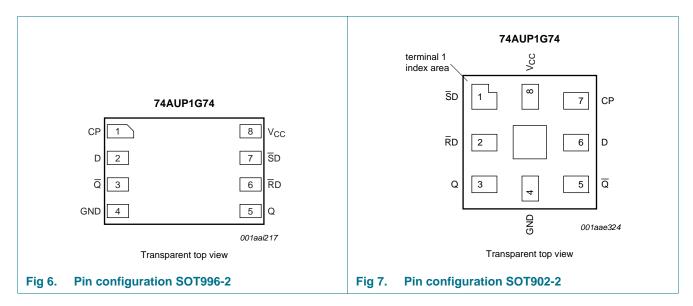


### 6. Pinning information





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### 6.2 Pin description

Symbol	Pin		Description
	SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
СР	1	7	clock input
D	2	6	data input
Q	3	5	complement output
GND	4	4	ground (0 V)
Q	5	3	true output
RD	6	2	asynchronous reset input (active LOW)
SD	7	1	asynchronous set input (active LOW)
V <sub>CC</sub>	8	8	supply voltage

### 7. Functional description

Table 4.	Function table for asy	/nchronous opera	ation <sup>[1]</sup>			
Input				Output		
SD	RD	СР	D	Q	Q	
L	Н	Х	Х	Н	L	
Н	L	Х	Х	L	Н	
L	L	Х	Х	Н	Н	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

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		lieue epolation_						
Input				Output				
SD	RD	СР	D	Q <sub>n+1</sub>	Q <sub>n+1</sub>			
Н	Н	$\uparrow$	L	L	Н			
Н	Н	↑	Н	Н	L			

#### Table 5. Function table for synchronous operation<sup>[1]</sup>

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

 $\uparrow$  = LOW-to-HIGH CP transition;

 $Q_{n+1}$  = state after the next LOW-to-HIGH CP transition.

### 8. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
Ι <sub>ΟΚ</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±20	mA
I <sub>CC</sub>	supply current		-	+50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For VSSOP8 packages: above 110 °C the value of Ptot derates linearly with 8.0 mW/K.

For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

### 9. Recommended operating conditions

Table 7.	Operating conditions				
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 0.8 V \text{ to } 3.6 V$	-	200	ns/V

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### **10. Static characteristics**

### Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

I P	Parameter	Conditions	Min	Тур	Max	Unit
25 °	°C					
F	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70\times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	2.0	-	-	V
L	OW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35\times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	-	-	0.9	V
F	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_O$ = –20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75\times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
	$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V	
	$I_{O} = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V	
	$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V	
L	OW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 20 $\mu A;$ $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.3\times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_{O}$ = 1.9 mA; $V_{CC}$ = 1.65 V	-	-	0.31	V
		$I_0$ = 2.3 mA; $V_{CC}$ = 2.3 V	-	-	0.31	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
ir	nput leakage current	$V_{I}$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V	-	-	±0.1	μΑ
р	oower-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V	-	-	±0.2	μΑ
	additional power-off eakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μΑ
S	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V \end{array}$	-	-	0.5	μΑ
а	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 0.6 \; V; \; I_{O} = 0 \; A; \\ V_{CC} = 3.3 \; V; \; per \; pin \end{array}$	<u>[1]</u> -	-	40	μΑ
ir	nput capacitance	$V_{CC} = 0$ V to 3.6 V; $V_{I} = GND$ or $V_{CC}$	-	0.6	-	pF
0	output capacitance	$V_0 = GND; V_{CC} = 0 V$	-	1.3	-	pF
ir	nput capacitance	$V_{CC}$ = 3.3 V; per pin $V_{CC}$ = 0 V to 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub>	<u>-</u>			40 - -

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#### Low-power D-type flip-flop with set and reset; positive-edge trigger

#### Symbol Parameter Conditions Max Unit Min Тур $T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$ $V_{CC} = 0.8 V$ V HIGH-level input voltage $0.70 \times V_{CC}$ -VIH \_ $V_{CC} = 0.9 \text{ V}$ to 1.95 V $0.65 \times V_{CC}$ -V - $V_{CC} = 2.3 \text{ V}$ to 2.7 V 1.6 V -- $V_{CC} = 3.0 V \text{ to } 3.6 V$ 2.0 V -\_ $V_{CC} = 0.8 V$ VIL LOW-level input voltage - $0.30 \times V_{CC}$ V - $V_{CC} = 0.9 V$ to 1.95 V $0.35 \times V_{CC} \ V$ -- $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ V 0.7 -- $V_{CC} = 3.0 \text{ V}$ to 3.6 V V 0.9 \_ -Vон HIGH-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ $I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V$ $V_{CC} - 0.1$ V \_ - $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $0.7 \times V_{CC}$ V -- $I_0 = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 1.03 V -- $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 1.30 V -\_ $I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.97 V -- $I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.85 V -- $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.67 V -- $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.55 V -- $V_{OL}$ LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ $I_{O} = 20 \ \mu A$ ; $V_{CC} = 0.8 \ V$ to 3.6 V V 0.1 -- $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ -- $0.3 \times V_{CC}$ V $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.37 V -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V 0.35 -- $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.33 V -- $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.45 V -- $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ V 0.33 -- $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.45 V -- $V_1 = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V ±0.5 μΑ I<sub>L</sub> input leakage current --**I**OFF power-off leakage current $V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V \_ ±0.5 μΑ additional power-off $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ $\Delta I_{OFF}$ ±0.6 μA -- $V_{CC} = 0 V \text{ to } 0.2 V$ leakage current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ 0.9 I<sub>CC</sub> supply current μΑ - $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A;$ <u>[1]</u> \_ $\Delta I_{CC}$ additional supply current 50 μΑ -

#### Static characteristics ... continued Table 8.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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#### Low-power D-type flip-flop with set and reset; positive-edge trigger

#### Symbol Parameter Conditions Max Unit Min Тур $T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$ $V_{CC} = 0.8 V$ V HIGH-level input voltage $0.75 \times V_{CC}$ -VIH \_ $V_{CC} = 0.9 \text{ V}$ to 1.95 V $0.70 \times V_{CC}$ -V - $V_{CC} = 2.3 \text{ V}$ to 2.7 V 1.6 V -- $V_{CC} = 3.0 \text{ V}$ to 3.6 V 2.0 V -\_ $V_{CC} = 0.8 V$ VIL LOW-level input voltage \_ $0.25 \times V_{CC}$ V - $V_{CC} = 0.9 V$ to 1.95 V $0.30 \times V_{CC} \ V$ -- $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ V 0.7 -- $V_{CC} = 3.0 \text{ V}$ to 3.6 V V 0.9 \_ -Vон HIGH-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ $I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V$ $V_{CC} - 0.11$ -V \_ $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $0.6 \times V_{CC}$ V -- $I_0 = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.93 V -- $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 1.17 V -\_ $I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.77 V -- $I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.67 V -- $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.40 V -- $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.30 V --LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ VOL $I_{O} = 20 \ \mu A$ ; $V_{CC} = 0.8 \ V$ to 3.6 V V 0.11 -- $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ -- $0.33 \times V_{CC}$ V $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.41 V -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V 0.39 -- $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.36 V -- $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.50 V -- $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ V 0.36 -- $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.50 V -- $V_1 = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V μΑ I<sub>L</sub> input leakage current ±0.75 --**I**OFF power-off leakage current $V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V \_ ±0.75 μΑ additional power-off $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ ±0.75 $\Delta I_{OFF}$ μA -- $V_{CC} = 0 V \text{ to } 0.2 V$ leakage current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ I<sub>CC</sub> supply current 1.4 μΑ - $V_{CC} = 0.8 V \text{ to } 3.6 V$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A;$ <u>[1]</u> \_ additional supply current 75 $\Delta I_{CC}$ μΑ $V_{CC} = 3.3 V$ ; per pin

#### Table 8. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND.

Low-power D-type flip-flop with set and reset; positive-edge trigger

### **11. Dynamic characteristics**

### Table 9. Dynamic characteristics

Symbol	Parameter	Conditions		Tai	<sub>mb</sub> = 25	°C	Ta	<sub>mb</sub> = -40 °	°C to +	125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Min	Max (125 °C)	_
$C_L = 5 p$	F							1		1	
t <sub>pd</sub>	propagation	CP to Q, $\overline{Q}$ ; see Figure 8	[2]								
	delay	$V_{CC} = 0.8 V$		-	25.4	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		2.9	6.7	14.0	2.6	14.2	2.6	14.2	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.4	4.5	7.6	2.3	8.3	2.3	8.6	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.9	3.5	5.7	1.7	6.5	1.7	6.8	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.7	2.6	3.8	1.4	4.4	1.4	4.7	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	2.2	3.1	1.2	3.4	1.2	3.7	ns
		$\overline{S}D$ to Q, $\overline{Q}$ ; see Figure 9	[2]								
		$V_{CC} = 0.8 V$		-	19.6	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		2.7	5.6	11.0	2.5	11.4	2.5	11.5	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.4	4.0	6.3	2.2	6.9	2.2	7.3	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.0	3.3	4.9	1.7	5.6	1.7	5.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.9	2.7	3.7	1.7	4.0	1.7	4.2	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.8	2.5	3.2	1.5	3.6	1.5	3.8	ns
		$\overline{R}D$ to Q, $\overline{Q}$ ; see Figure 9	[2]								
		$V_{CC} = 0.8 V$		-	19.2	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		2.6	5.5	11.0	2.5	11.3	2.5	11.5	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.3	3.9	6.3	2.2	6.8	2.2	7.3	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.9	3.2	5.0	1.8	5.6	1.8	5.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.9	2.6	3.6	1.7	4.1	1.7	4.3	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.8	2.4	3.3	1.5	3.6	1.5	3.8	ns
f <sub>max</sub>	maximum	CP; see Figure 8									
	frequency	$V_{CC} = 0.8 V$		-	53	-	-	-	-	-	MHz
		$V_{CC}$ = 1.1 V to 1.3 V		-	203	-	170	-	170	-	MHz
		$V_{CC}$ = 1.4 V to 1.6 V		-	347	-	310	-	300	-	MHz
		$V_{CC}$ = 1.65 V to 1.95 V		-	435	-	400	-	390	-	MHz
		$V_{CC}$ = 2.3 V to 2.7 V		-	550	-	490	-	480	-	MHz
		$V_{CC}$ = 3.0 V to 3.6 V		-	619	-	550	-	510	-	MHz

# 74AUP1G74

#### Low-power D-type flip-flop with set and reset; positive-edge trigger

Symbol	Parameter	Conditions		Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> = -40 °C to +125 °C				Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Min	Max (125 °C)	
C <sub>L</sub> = 10	pF										
pd	propagation	CP to Q, Q; see Figure 8	[2]								
	delay	$V_{CC} = 0.8 V$		-	28.9	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.1	7.5	15.8	2.9	16.1	2.9	16.1	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.7	5.1	8.7	2.4	9.4	2.4	9.8	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.5	4.1	6.5	2.2	7.2	2.2	7.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	3.2	4.6	1.8	5.3	1.8	5.6	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.8	2.8	3.8	1.6	4.1	1.6	4.4	ns
		SD to Q, $\overline{Q}$ ; see Figure 9	[2]								
	$V_{CC} = 0.8 V$		-	23.2	-	-	-	-	-	ns	
		$V_{CC}$ = 1.1 V to 1.3 V		2.9	6.5	12.9	2.8	13.3	2.8	13.5	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.7	4.6	7.5	2.3	7.9	2.3	8.3	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.6	3.9	5.6	2.3	6.3	2.3	6.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.3	3.2	4.4	2.0	4.8	2.0	5.2	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.2	3.0	3.9	1.9	4.2	1.9	4.4	ns
		$\overline{RD}$ to Q, $\overline{Q}$ ; see <u>Figure 9</u>	[2]								
		$V_{CC} = 0.8 V$		-	22.7	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		2.8	6.4	12.8	2.7	13.2	2.7	13.4	ns
		$V_{CC}$ = 1.4 V to 1.6 V		2.6	4.5	7.5	2.3	8.1	2.3	8.4	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.5	3.3	5.8	2.3	6.3	2.3	6.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.2	3.2	4.4	2.0	4.9	2.0	5.2	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.0	2.9	4.0	1.9	4.3	1.9	4.5	ns
max	maximum	CP; see Figure 8									
	frequency	$V_{CC} = 0.8 V$		-	52	-	-	-	-	-	Мŀ
		$V_{CC}$ = 1.1 V to 1.3 V		-	192	-	150	-	150	-	MH
		$V_{CC}$ = 1.4 V to 1.6 V		-	324	-	280	-	230	-	MH
		$V_{CC}$ = 1.65 V to 1.95 V		-	421	-	310	-	250	-	Мŀ
		$V_{CC}$ = 2.3 V to 2.7 V		-	486	-	370	-	360	-	MF
	$V_{CC}$ = 3.0 V to 3.6 V		-	550	-	410	-	360	-	MH	

### Table 9. Dynamic characteristics ...continued

# 74AUP1G74

#### Low-power D-type flip-flop with set and reset; positive-edge trigger

Symbol	Parameter	Conditions	Conditions		<sub>mb</sub> = 25	°C	T <sub>amb</sub> = –40 °C to +125 °C				Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Min	Max (125 °C)	
C <sub>L</sub> = 15	pF										
t <sub>pd</sub>	propagation	CP to Q, $\overline{Q}$ ; see Figure 8	[2]								
	delay	$V_{CC} = 0.8 V$		-	32.4	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.5	8.3	17.6	3.3	17.8	3.3	18.0	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		3.2	5.6	9.5	2.8	10.5	2.8	11.1	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.7	4.6	7.2	2.5	8.1	2.5	8.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.4	3.6	5.2	2.2	5.8	2.2	6.2	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.2	3.2	4.4	2.0	4.9	2.0	5.2	ns
		$\overline{SD}$ to Q, $\overline{Q}$ ; see <u>Figure 9</u>	[2]								
		$V_{CC} = 0.8 V$		-	26.7	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.3	7.3	14.7	3.1	15.2	3.1	15.4	ns
		$V_{CC}$ = 1.4 V to 1.6 V		3.2	5.2	8.3	2.9	9.0	2.9	9.5	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.8	4.3	6.4	2.5	7.1	2.5	7.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.8	3.7	5.1	2.2	5.5	2.2	5.8	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.5	3.5	4.6	2.4	5.0	2.4	5.2	ns
		RD to Q, $\overline{Q}$ ; see Figure 9	[2]								
		$V_{CC} = 0.8 V$		-	26.1	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		3.2	7.2	14.5	3.1	15.0	3.1	15.2	ns
		$V_{CC}$ = 1.4 V to 1.6 V		3.1	5.1	8.4	2.7	9.2	2.7	9.7	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.7	4.3	6.5	2.6	7.3	2.6	7.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.6	3.6	5.0	2.4	5.5	2.4	5.8	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.4	3.4	4.6	2.3	5.0	2.3	5.2	ns
f <sub>max</sub>	maximum	CP; see Figure 8									
	frequency	$V_{CC} = 0.8 V$		-	50	-	-	-	-	-	MF
		$V_{CC}$ = 1.1 V to 1.3 V		-	181	-	120	-	120	-	MH
		$V_{CC}$ = 1.4 V to 1.6 V		-	301	-	190	-	160	-	MH
		$V_{CC}$ = 1.65 V to 1.95 V		-	407	-	240	-	190	-	Мŀ
		$V_{CC}$ = 2.3 V to 2.7 V		-	422	-	300	-	270	-	Мŀ
		$V_{CC}$ = 3.0 V to 3.6 V		-	481	-	320	-	300	-	MH

### Table 9. Dynamic characteristics ...continued

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#### Low-power D-type flip-flop with set and reset; positive-edge trigger

Symbol	Parameter	Conditions		Tai	<sub>nb</sub> = 25	°C	Ta	<sub>mb</sub> = -40 °	°C to +	125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Min	Max (125 °C)	
C <sub>L</sub> = 30	pF										•
t <sub>pd</sub>	propagation	CP to Q, Q; see Figure 8	[2]								
	delay	$V_{CC} = 0.8 V$		-	42.7	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		4.2	10.6	22.5	4.0	23.0	4.0	23.3	ns
		$V_{CC}$ = 1.4 V to 1.6 V		3.7	7.2	12.0	3.7	13.3	3.7	14.0	ns
		$V_{CC}$ = 1.65 V to 1.95 V		3.5	5.8	9.2	3.4	10.4	3.4	11.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		3.3	4.7	6.6	3.0	7.3	3.0	7.8	ns
		$V_{CC}$ = 3.0 V to 3.6 V		3.0	4.3	5.8	2.8	6.8	2.8	7.3	ns
		$\overline{SD}$ to Q, $\overline{Q}$ ; see Figure 9	[2]								
		$V_{CC} = 0.8 V$		-	37.0	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		4.0	9.5	19.8	3.8	20.8	3.8	21.1	ns
		$V_{CC}$ = 1.4 V to 1.6 V		3.8	6.7	10.9	3.7	12.0	3.7	12.7	ns
		$V_{CC}$ = 1.65 V to 1.95 V		3.7	5.6	8.4	3.5	9.3	3.5	9.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V		3.7	4.8	6.6	3.2	7.2	3.2	7.6	ns
		$V_{CC}$ = 3.0 V to 3.6 V		3.4	4.6	6.0	3.1	6.8	3.1	7.1	ns
		$\overline{RD}$ to Q, $\overline{Q}$ ; see Figure 9	[2]								
		$V_{CC} = 0.8 V$		-	36.4	-	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V		3.9	9.4	19.5	3.8	20.2	3.8	20.5	ns
		$V_{CC}$ = 1.4 V to 1.6 V		3.6	6.6	10.9	3.7	12.0	3.7	12.6	ns
		$V_{CC}$ = 1.65 V to 1.95 V		3.5	5.5	8.5	3.5	9.5	3.5	10.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V		3.5	4.7	6.5	3.2	7.1	3.2	7.6	ns
		$V_{CC}$ = 3.0 V to 3.6 V		3.3	4.4	6.1	3.1	7.1	3.1	7.5	ns
max	maximum	CP; see Figure 8									
	frequency	$V_{CC} = 0.8 V$		-	28	-	-	-	-	-	MH
		$V_{CC}$ = 1.1 V to 1.3 V		-	145	-	70	-	70	-	MH
		$V_{CC}$ = 1.4 V to 1.6 V		-	185	-	120	-	110	-	MH
		$V_{CC}$ = 1.65 V to 1.95 V		-	270	-	150	-	120	-	MH
		$V_{CC}$ = 2.3 V to 2.7 V		-	290	-	190	-	170	-	MH
		$V_{CC}$ = 3.0 V to 3.6 V		-	315	-	200	-	190	-	MH

### Table 9. Dynamic characteristics ...continued

#### Low-power D-type flip-flop with set and reset; positive-edge trigger

### Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 10</u>.

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> = -40 °C to +125 °C			Unit	
			Min	Тур <mark>[1]</mark>	Max	Min	Max (85 °C)	Min	Max (125 °C)	
C <sub>L</sub> = 5 p	F, 10 pF, 15 pF an	d 30 pF					1			
t <sub>su</sub>	set-up time	D to CP HIGH; see <u>Figure 8</u>								
		$V_{CC} = 0.8 V$	-	3.4	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	0.6	-	1.2	-	1.2	-	ns
		$V_{CC}$ = 1.4 V to 1.6 V	-	0.3	-	0.6	-	0.6	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	0.4	-	0.5	-	0.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	0.2	-	0.4	-	0.4	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.3	-	0.4	-	0.4	-	ns
		D to CP LOW; see <u>Figure 8</u>								
		V <sub>CC</sub> = 0.8 V	-	3.0	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	0.5	-	1.2	-	1.2	-	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	0.3	-	0.7	-	0.7	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	0.4	-	0.7	-	0.7	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	0.5	-	0.7	-	0.7	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.6	-	0.8	-	0.8	-	ns
<sup>t</sup> h	hold time	D to CP; see Figure 8								
		V <sub>CC</sub> = 0.8 V	-	-1.9	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	-0.3	-	0.5	-	0.5	-	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	-0.2	-	0.2	-	0.2	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	-0.2	-	0.1	-	0.1	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	-0.2	-	0.1	-	0.1	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-0.2	-	0.1	-	0.1	-	ns
rec	recovery time	RD; see Figure 9								
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	-0.5	-	-0.9	-	-0.9	-	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	-0.2	-	-0.6	-	-0.6	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	-0.2	-	-0.4	-	-0.4	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	-0.1	-	-0.1	-	-0.1	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-0.1	-	-0.1	-	-0.1	-	ns
		SD; see Figure 9								
		$V_{CC}$ = 1.1 V to 1.3 V	-	-0.5	-	-0.3	-	-0.3	-	ns
		$V_{CC}$ = 1.4 V to 1.6 V	-	-0.4	-	-0.1	-	-0.1	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	-0.3	-	0	-	0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	-0.2	-	0.1	-	0.1	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V	-	-0.1	-	0.1	-	0.1	-	ns

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#### Low-power D-type flip-flop with set and reset; positive-edge trigger

Symbol	Parameter	Conditions		Tan	<sub>nb</sub> = 25	°C	Tar	nb = -40 °	°C to +	125 °C	Unit
				<b>/</b> in	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Min	Max (125 °C)	
t <sub>W</sub>	pulse width	CP HIGH or LOW; see <u>Figure 8</u>									
		$V_{CC}$ = 1.1 V to 1.3 V		-	2.1	-	2.7	-	2.7	-	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		-	1.1	-	1.5	-	1.5	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		-	0.9	-	1.6	-	1.6	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		-	0.6	-	1.7	-	1.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	0.6	-	1.9	-	1.9	-	ns
		SD or RD LOW; see <u>Figure 9</u>									
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		-	4.2	-	11.3	-	11.5	-	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		-	2.3	-	6.2	-	6.4	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		-	1.8	-	4.8	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		-	1.2	-	3.3	-	3.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	1.1	-	2.6	-	2.8	-	ns
$C_{PD}$	power dissipation	$f_i = 1 \text{ MHz};$ V <sub>I</sub> = GND to V <sub>CC</sub>	<u>[3]</u>								
	capacitance	$V_{CC} = 0.8 V$		-	2.8	-	-	-	-	-	pF
		$V_{CC}$ = 1.1 V to 1.3 V		-	2.9	-	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	3.0	-	-	-	-	-	pF
		$V_{CC}$ = 1.65 V to 1.95 V		-	3.0	-	-	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	3.5	-	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	3.9	-	-	-	-	-	pF

#### Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

[1] All typical values are measured at nominal  $V_{CC}$ .

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

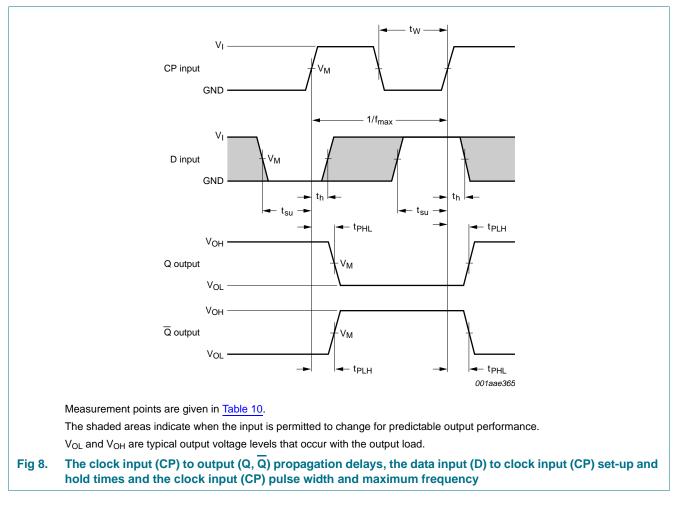
 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

#### Low-power D-type flip-flop with set and reset; positive-edge trigger

### 12. Waveforms

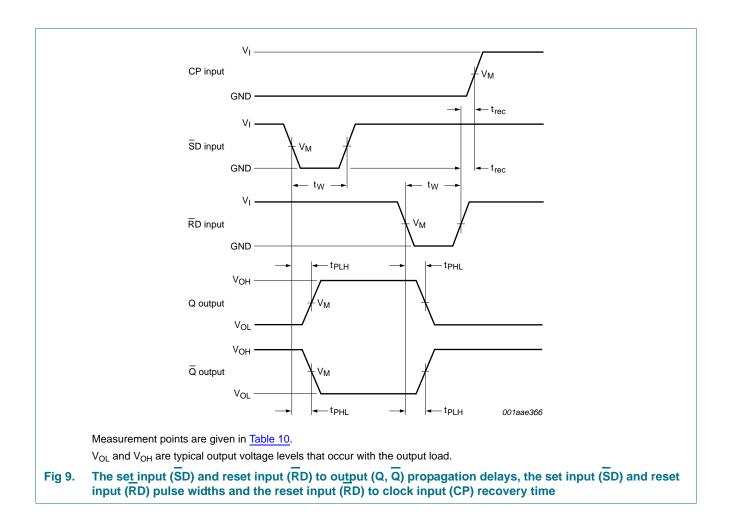


#### Table 10. Measurement points

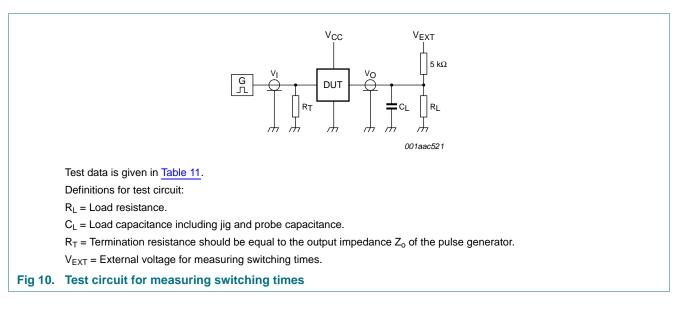
Supply voltage	Output	Input			
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>	VI	t <sub>r</sub> = t <sub>f</sub>	
0.8 V to 3.6 V	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$	V <sub>CC</sub>	≤ 3.0 ns	

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Low-power D-type flip-flop with set and reset; positive-edge trigger



#### Low-power D-type flip-flop with set and reset; positive-edge trigger



### Table 11. Test data

Supply voltage	Load		V <sub>EXT</sub>		
V <sub>cc</sub>	CL	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k $\Omega$ or 1 M $\Omega$	open	GND	$2 \times V_{CC}$

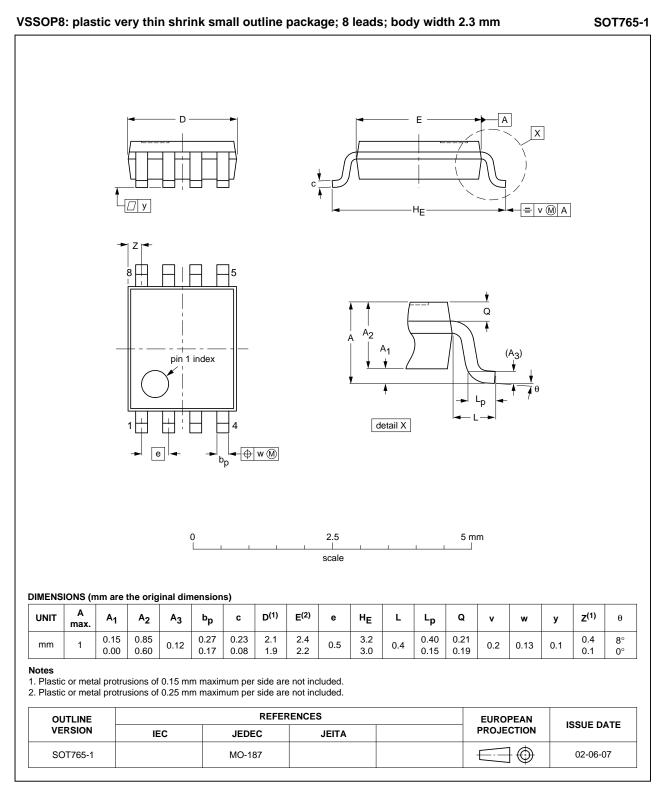
[1] For measuring enable and disable times  $R_L = 5 \text{ k}\Omega$ 

For measuring propagation delays, setup and hold times and pulse width  $R_L$  = 1 M $\Omega$ .

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Low-power D-type flip-flop with set and reset; positive-edge trigger

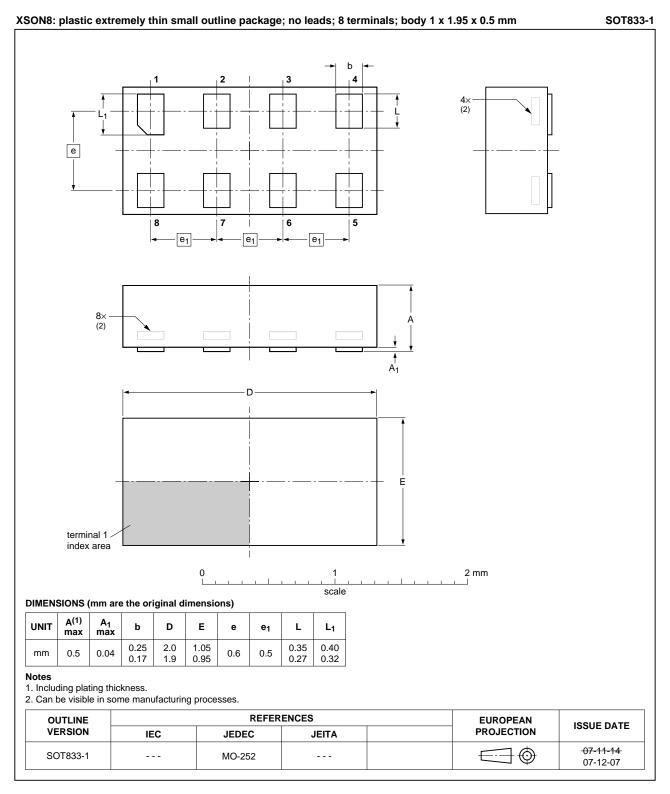
### 13. Package outline



#### Fig 11. Package outline SOT765-1 (VSSOP8)

74AUP1G74 Product data sheet

#### Low-power D-type flip-flop with set and reset; positive-edge trigger

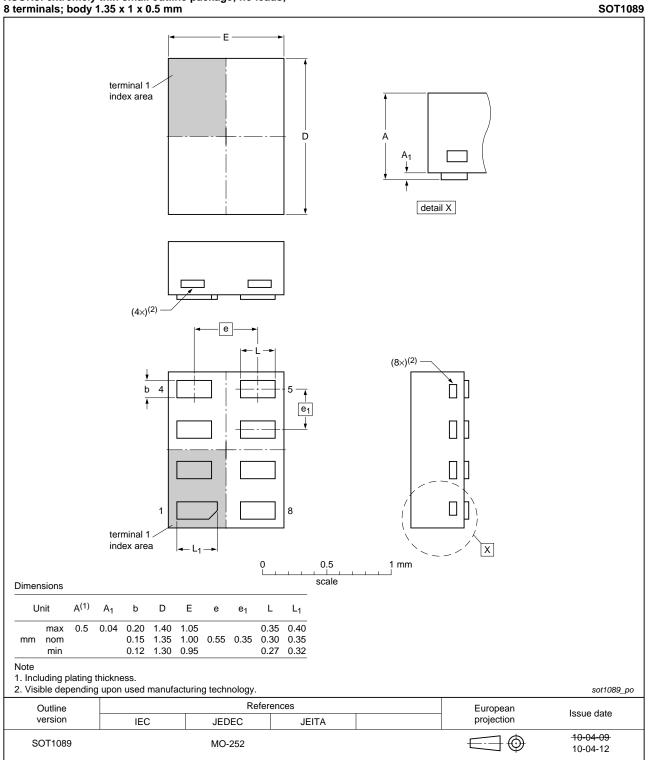


#### Fig 12. Package outline SOT833-1 (XSON8)

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Low-power D-type flip-flop with set and reset; positive-edge trigger

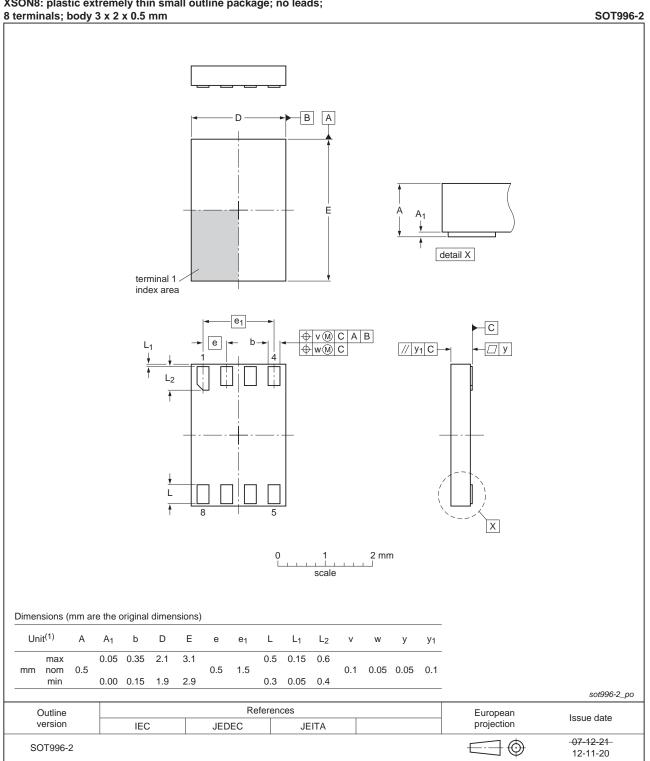


# XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 13. Package outline SOT1089 (XSON8)

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Low-power D-type flip-flop with set and reset; positive-edge trigger



XSON8: plastic extremely thin small outline package; no leads;

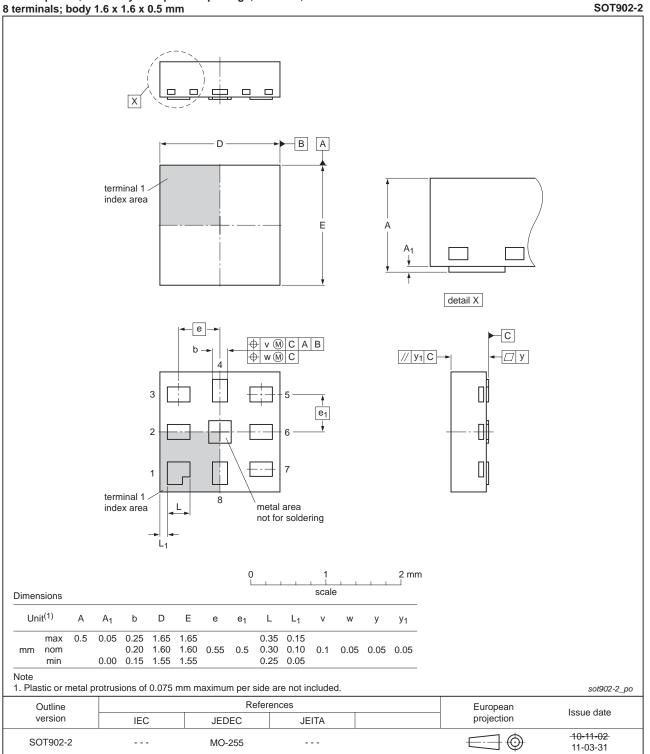
Fig 14. Package outline SOT996-2 (XSON8)

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Low-power D-type flip-flop with set and reset; positive-edge trigger

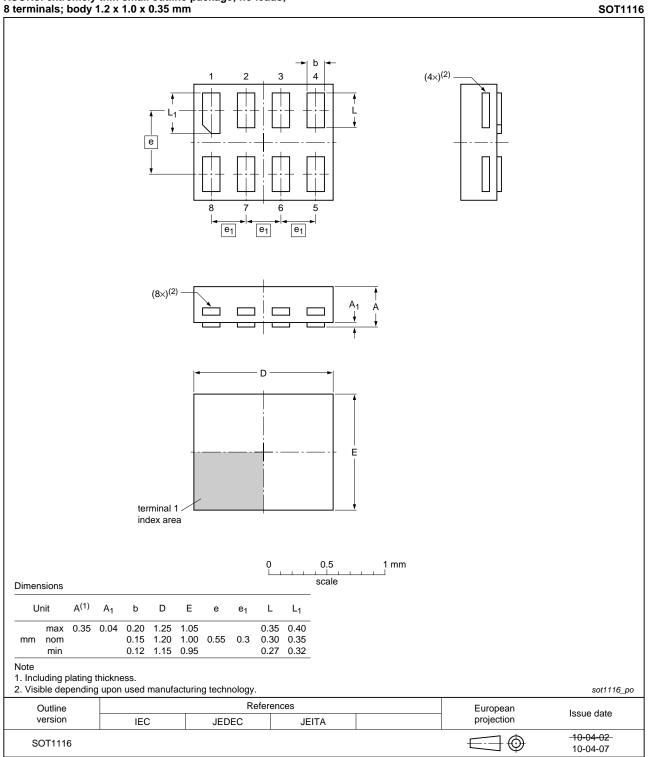


XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals: body 1.6 x 1.6 x 0.5 mm

Fig 15. Package outline SOT902-2 (XQFN8)

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Low-power D-type flip-flop with set and reset; positive-edge trigger



# XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

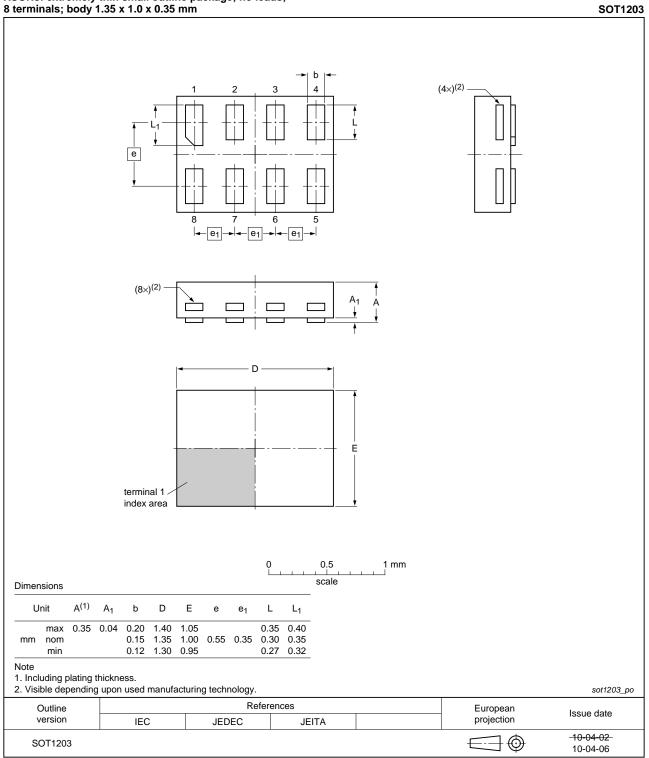
Fig 16. Package outline SOT1116 (XSON8)

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All

Low-power D-type flip-flop with set and reset; positive-edge trigger



# XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 17. Package outline SOT1203 (XSON8)

Low-power D-type flip-flop with set and reset; positive-edge trigger

### 14. Abbreviations

Table 12. Abb	eviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

### **15. Revision history**

#### Table 13. Revision history **Document ID Release date** Data sheet status Change notice Supersedes 74AUP1G74 v.9 20140106 Product data sheet 74AUP1G74 v.8 -Modifications: • Conditions for f<sub>max</sub> corrected (errata). 74AUP1G74 v.8 20130123 Product data sheet 74AUP1G74 v.7 -Modifications: For type number 74AUP1G74GD XSON8U has changed to XSON8. 74AUP1G74 v.7 20120522 Product data sheet 74AUP1G74 v.6 -74AUP1G74 v.6 20111128 Product data sheet 74AUP1G74 v.5 -74AUP1G74 v.5 20100726 Product data sheet 74AUP1G74 v.4 \_ 74AUP1G74 v.4 20080603 Product data sheet 74AUP1G74 v.3 -74AUP1G74 v.3 20080207 Product data sheet 74AUP1G74 v.2 -74AUP1G74 v.2 20070515 Product data sheet 74AUP1G74 v.1 -74AUP1G74 v.1 20060825 Product data sheet --

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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